



New Product

SiP2213

Vishay Siliconix

## Dual Output Low Dropout Regulator

### FEATURES

- 2.25-V to 5.5-V Input Voltage Range
- Two Outputs – 150 mA and 300 mA
- Low Ground Current
- Open Drain Driver Output
- POR
- Current Limit
- Thermal Shutdown
- MLP33-10 and MLP44-16 PowerPAK® Packages

### APPLICATIONS

- Cellular Phones
- Wireless Modems
- PDAs

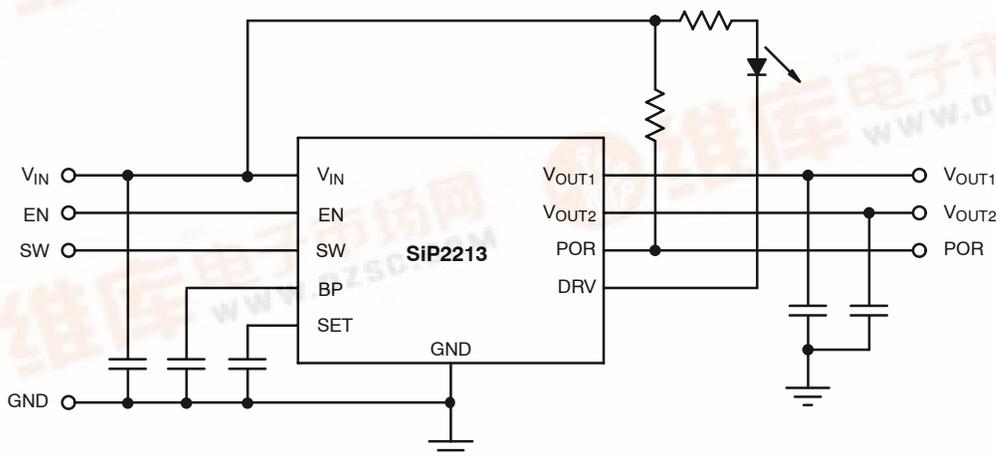
### DESCRIPTION

The SiP2213 is a dual output low dropout regulator capable of supplying 150 mA from output 1 and 300 mA from output 2. In the SiP2213, the outputs are sequenced at power on. The output of LDO #1 has to settle before the output of LDO #2 begins turning on. In addition to the LDOs, an open drain output has been included, which is capable of sinking 150 mA. The SiP2213 offers a low dropout, low ground current and extremely low noise with the addition of a bypass capacitor.

Protection features include POR with adjustable delay, undervoltage lockout, output current limit, and thermal shutdown.

The fixed output version of SiP2213 is available in the MLP33-10 PowerPAK package and the adjustable version is available in the MLP44-16 PowerPAK package. Both packages are specified to operate over the range of  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

### TYPICAL APPLICATION CIRCUIT



# SiP2213

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## ABSOLUTE MAXIMUM RATINGS

$V_{IN}$ , $V_{EN}$ , to GND	.....	-0.3 V to 7 V
Power Dissipation		
MLP33-10 PowerPAK <sup>b</sup>	.....	1600 mW
MLP44-16 PowerPAK <sup>c</sup>	.....	1880 mW
Storage Temperature	.....	-55 to 150°C

Thermal Resistance		
MLP33-10 PowerPAK <sup>a</sup>	.....	50 °C/W
MLP44-16 PowerPAK <sup>a</sup>	.....	43 °C/W

Notes:

- a. Device mounted with all leads soldered or welded to PC board.
- b. Derate 20 mW/°C above 70°C
- c. Derate 23.5 mW/°C above 70°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING RANGE

Input Voltage Range	.....	2.25 V to 5.5 V
Enable Voltage Range	.....	0 V to 5.5 V

Operating Temperature Range $T_A$	.....	-40 to 85°C
Operating Temperature Range $T_J$	.....	-40 to 125°C

SPECIFICATIONS								
Parameter	Symbol	Test Conditions Unless Specified $V_{IN} = V_{OUT} + 1 V$ , $C_{OUT} = 1 \mu F$ , $I_{OUT} = 100 \mu A$ , $T_A = 25^\circ C$	Temp <sup>a</sup>	Limits			Unit	
				Min <sup>b</sup>	Typ <sup>c</sup>	Max <sup>b</sup>		
<b>Regulators</b>								
Output Voltage Accuracy		From Nominal $V_{OUT}$	Room	-1		1	%	
			Full	-2		2		
Output Voltage Temperature Coefficient			Room		40		ppm/°C	
Line Regulation <sup>f</sup>		$V_{IN} = V_{OUT} + 1 V$ to 5.5 V	Room	-0.3	0.2	0.3	%	
			Full	-0.6		0.6		
Load Regulation		$I_{OUT} = 100 \mu A$ to 150 mA (LDO 1 and 2)	Room			0.2	%	
		$I_{OUT} = 100 \mu A$ to 300 mA (LDO 2)	Room			1.5		
Dropout Voltage <sup>g</sup>	$V_{DROP}$	$I_{OUT} = 150 mA$ (LDO 1 and 2)	Room			120	mV	
			Full			250		
		$I_{OUT} = 300 mA$ (LDO 2)	Room			240		340
			Full			420		420
Ground Pin Current	$I_G$	$I_{OUT1} = I_{OUT2} = 0 \mu A$	Room			48	μA	
			Full			80		
		$I_{OUT1} = 150 mA$ , $I_{OUT2} = 300 mA$	Room			60		
			Full					2.0
Sequence Time Delay <sup>d</sup>	$t_{SEQ}$		Room		70		μs	
Output Voltage Noise		$C_{BP} = 0.01 \mu F$				30	μVrms	
Ripple Rejection		$f = 1 kHz$ , $C_{OUT} = 1 \mu F$ , $C_{BP} = 10 nF$	Room			60	dB	
		$f = 20 kHz$ , $C_{OUT} = 1 \mu F$ , $C_{BP} = 10 nF$	Room			40		
<b>Inputs</b>								
EN, SW Input Voltage	$V_{IL}$	Logic Low	Full			0.6	V	
	$V_{IH}$	Logic High	Full	1.8				
EN, SW Input Current	$I_{IL}$	$V_{IL} < 0.6 V$	Room	-1	0.01	1	μA	
	$I_{IH}$	$V_{IH} > 1.8 V$	Room	-1	0.01	1		
SET Pin Threshold Voltage	$V_{TH(set)}$	POR = High	Room		1.25		V	
SET Pin Current Source		$V_{SET} = 0 V$	Room	0.75	1.25	1.75	μA	
<b>Power On Reset (POR) Output</b>								
Threshold	$V_{THL}$	% of Nominal $V_{OUT2}$	Room	90			%	
	$V_{THH}$		Room			96		
Output Voltage	$V_{OL}$	$I_L = 250 \mu A$	Room		0.02	0.1	V	
Leakage Current	$I_{POR}$	POR = High	Room	-1	0.01	1	μA	
<b>Driver (DRV) Output</b>								
Output Voltage	$V_{OL}$	$I_L = 150 mA$	Full		0.2	0.6	V	
Leakage Current		$I_{DRV} = 0 mA$ , $V_{DRV} = 5.5 V$ , $SW = 0 V$	Room	-1	0.01	1	μA	

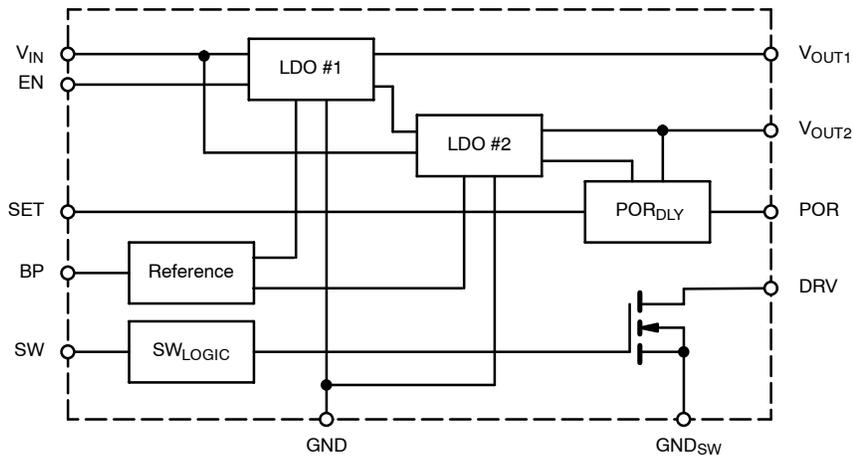


SPECIFICATIONS							
Parameter	Symbol	Test Conditions Unless Specified $V_{IN} = V_{OUT} + 1\text{ V}$ , $C_{OUT} = 1\ \mu\text{F}$ , $I_{OUT} = 100\ \mu\text{A}$ , $T_A = 25^\circ\text{C}$	Temp <sup>a</sup>	Limits			Unit
				Min <sup>b</sup>	Typ <sup>c</sup>	Max <sup>b</sup>	
<b>Protection</b>							
Current Limit	$I_{IL}$	$V_{OUT1} = 0\text{ V}$	Room	150	280	460	mA
		$V_{OUT2} = 0\text{ V}$	Room	300	450	700	
Thermal Shutdown Temperature			Room		165		$^\circ\text{C}$
Thermal Hysteresis			Room		25		

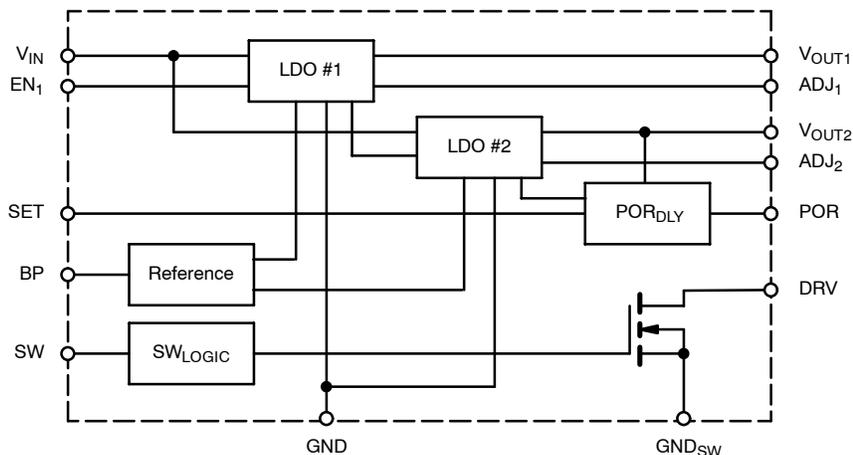
Notes

- Room = 25°C, Full = -40 to 85°C.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- Timing is measured from 90% of LDO #1's final value to 90% of LDO #2's final value.
- Guaranteed by design.
- For higher output of the regulator pair.
- Dropout voltage is defined as the input to output differential voltage at which the output voltage drops 2% below the output voltage measured with a 1-V differential, provided that  $V_{IN}$  does not drop below 2.25 V. When  $V_{OUT(nom)}$  is less than 2.25 V, the output will be in regulation when  $2.25\text{ V} - V_{OUT(nom)}$  is greater than the dropout voltage specified.

**FUNCTIONAL BLOCK DIAGRAM**



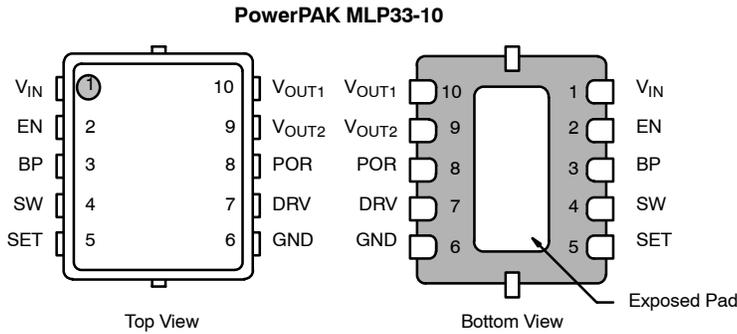
Fixed Voltage Version



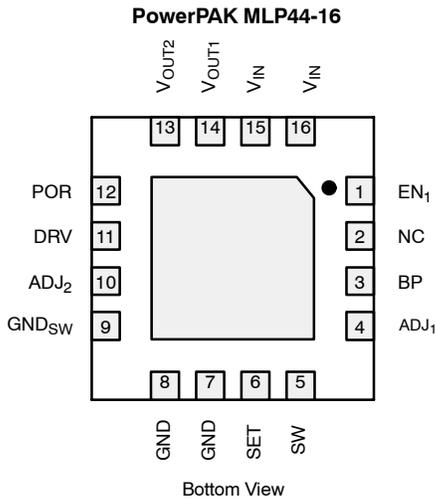
Adjustable Voltage Version



### PIN CONFIGURATIONS AND ORDERING INFORMATION



VOLTAGE OPTIONS	
Voltage	Code (x,z)
Adj	A
1.5	F
1.6	W
1.8	G
1.9	Y
2.0	H
2.1	E
2.5	J
2.6	K
2.7	L
2.8	M
2.85	N
2.9	O
3.0	P
3.1	Q
3.2	R
3.3	S
3.4	T
3.5	U
3.6	V



ORDERING INFORMATION			
Part Number	Temp Range	Package	Marking
SiP2213DMP-XZ-T1	-40 to 85°C	PowerPAK MLP33-10	13XZ
SiP2213DLP-AA-T1		PowerPAK MLP44-16	13AA

X: Output 1 voltage code  
Z: Output 2 voltage code

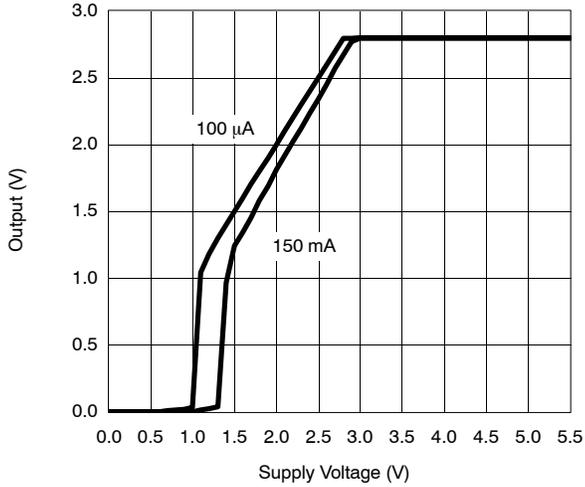
PIN DESCRIPTION			
Pin Number		Name	Function
MLP33-10	MLP44-16		
1	15, 16	V <sub>IN</sub>	Input voltage for the power MOSFETs and their gate drive
2		EN	Enables both LDO outputs.
	1	EN	Enables both LDO outputs.
	2	NC	No Connect
3	3	BP	Bypass for noise reduction
4	5	SW	Control for open drain output
	4	ADJ <sub>1</sub>	Feedback connection for LDO #1
5	6	SET	Connection for external capacitor to delay POR
6	7, 8	GND	Ground
	9	GND <sub>SW</sub>	Ground for the internal n-channel MOSFET switch
	10	ADJ <sub>2</sub>	Feedback connection for LDO #2
7	11	DRV	Open drain output
8	12	POR	Power ON reset output
9	13	V <sub>OUT2</sub>	Output of LDO #2 – 300 mA
10	14	V <sub>OUT1</sub>	Output of LDO #1 – 150 mA

The exposed pad on both packages must be connected externally to the GND pin.

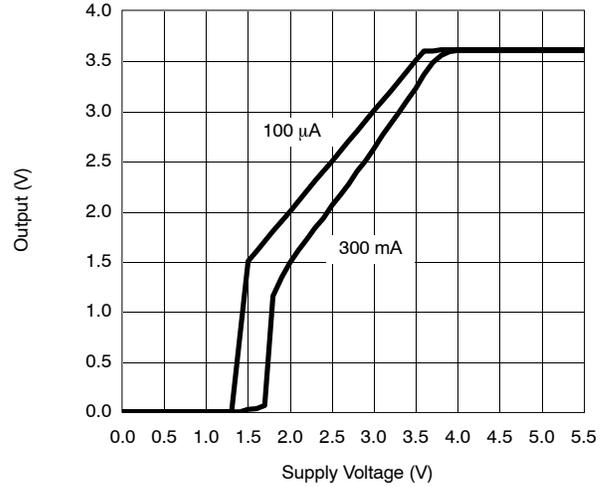


**TYPICAL CHARACTERISTICS**

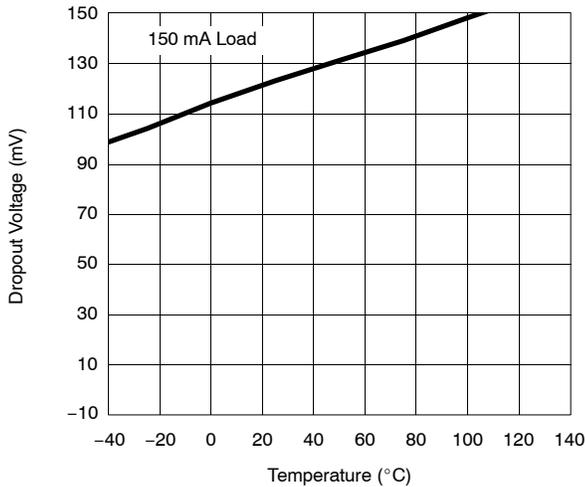
**Dropout Characteristics—Output 1**



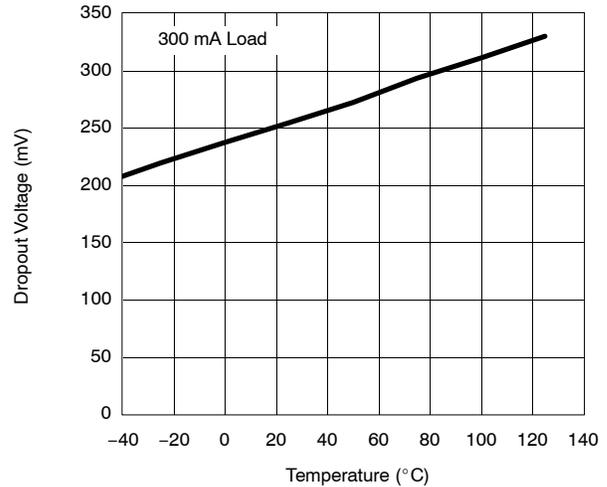
**Dropout Characteristics—Output 2**



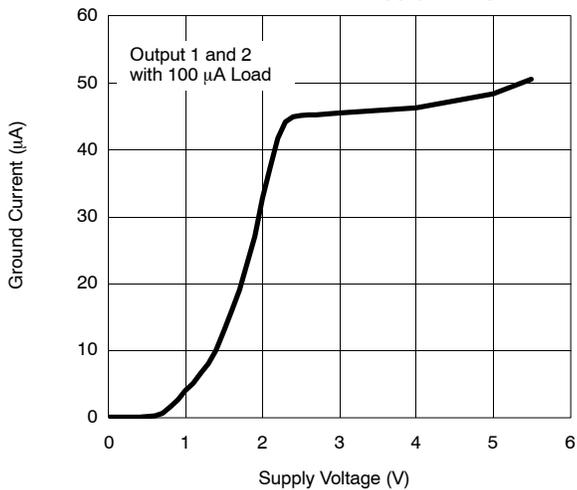
**Dropout Voltage—Output 1**



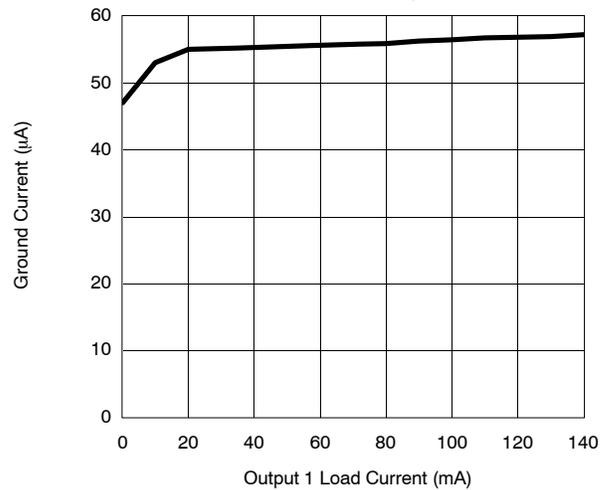
**Dropout Voltage—Output 2**



**Ground Current vs. Supply Voltage**



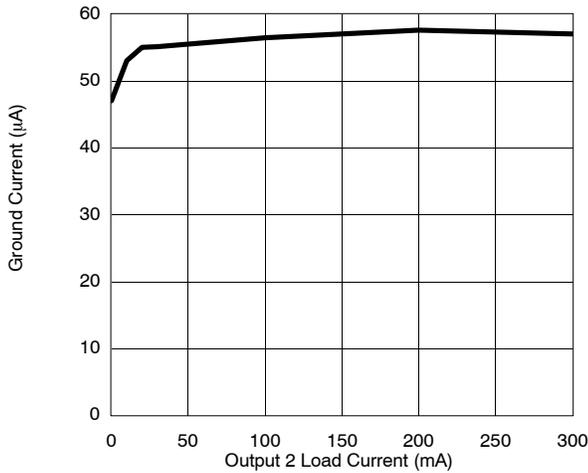
**Ground Current vs. Output 1 Current**



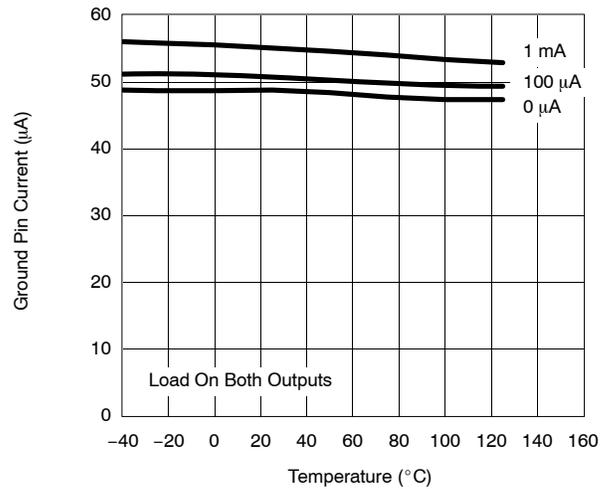


**TYPICAL CHARACTERISTICS**

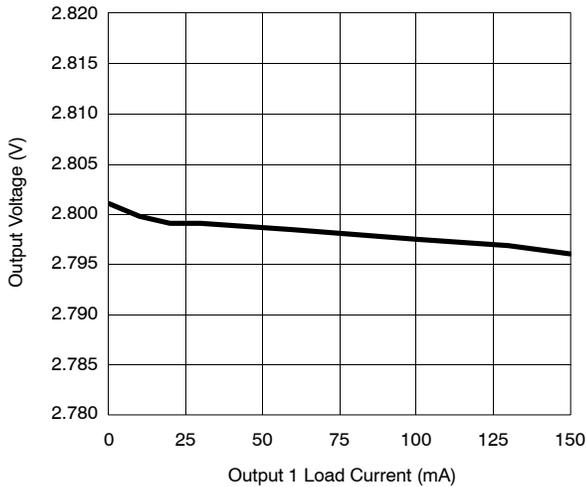
**Ground Current vs. Output 2 Current**



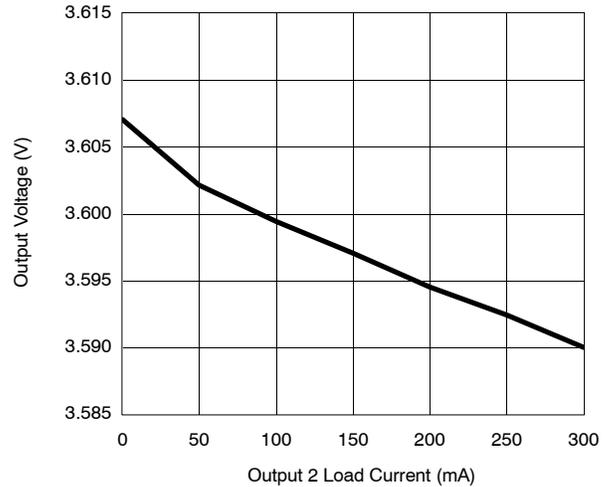
**Ground Pin Current**



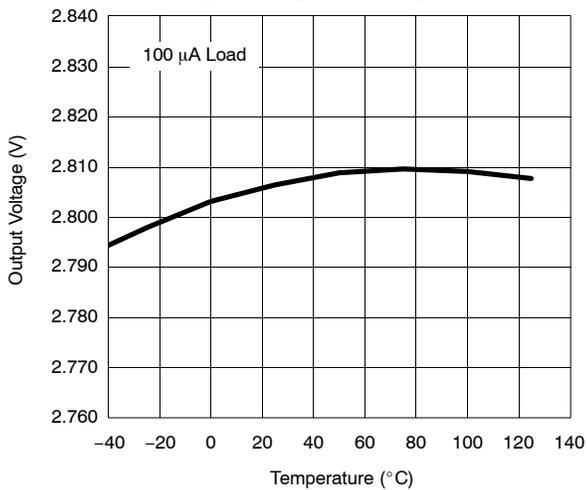
**Output Voltage vs. Load Current—Output 1**



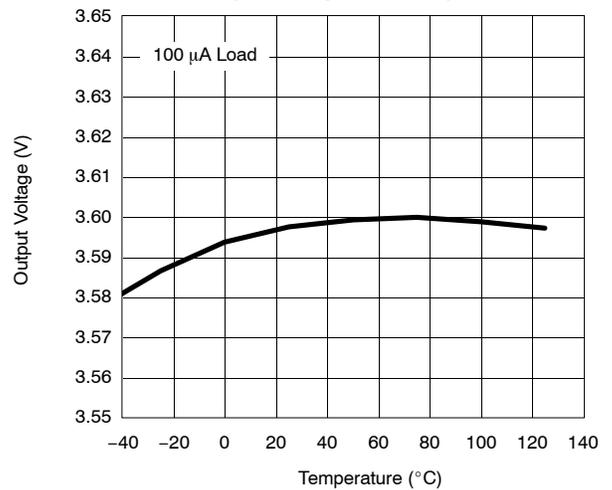
**Output Voltage vs. Load Current—Output 2**



**Output Voltage 1 vs. Temperature**



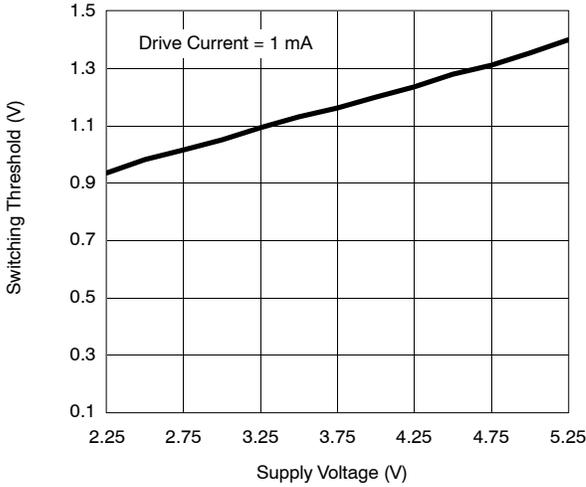
**Output Voltage 2 vs. Temperature**



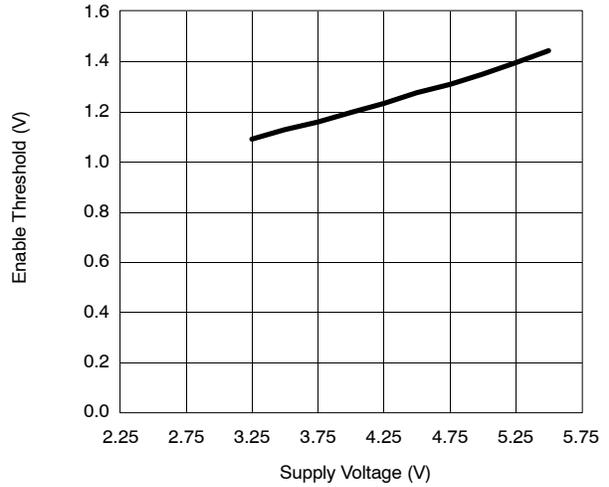


**TYPICAL CHARACTERISTICS**

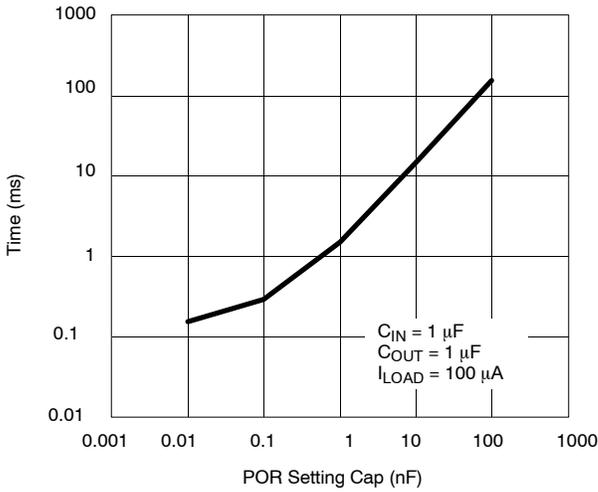
Switch Threshold vs. Supply Voltage



Enable Voltage Threshold vs. Supply Voltage



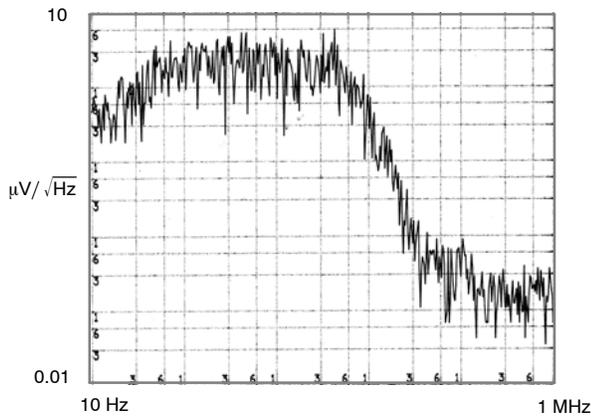
POR Delay



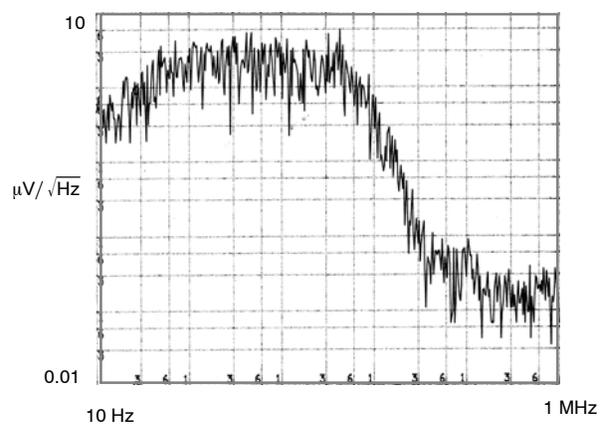


**TYPICAL WAVEFORMS**

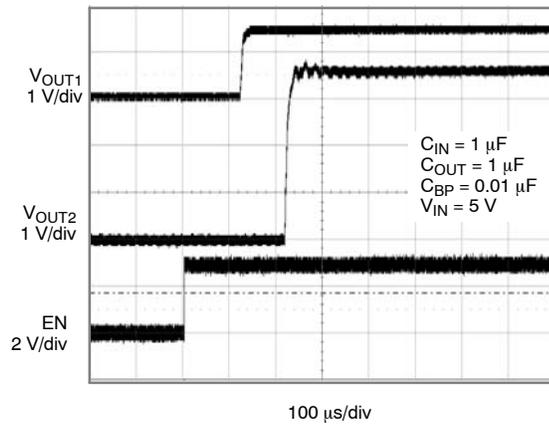
**Noise Spectrum Output 1**



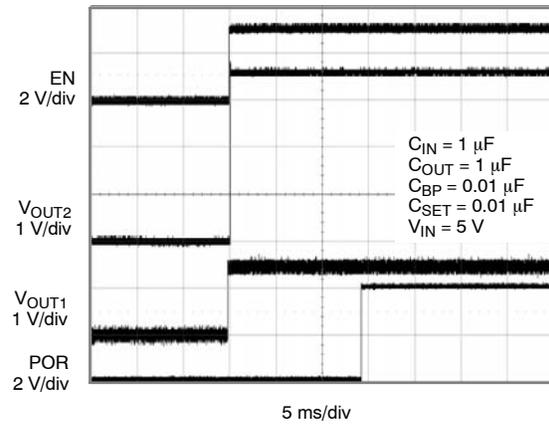
**Noise Spectrum Output 2**



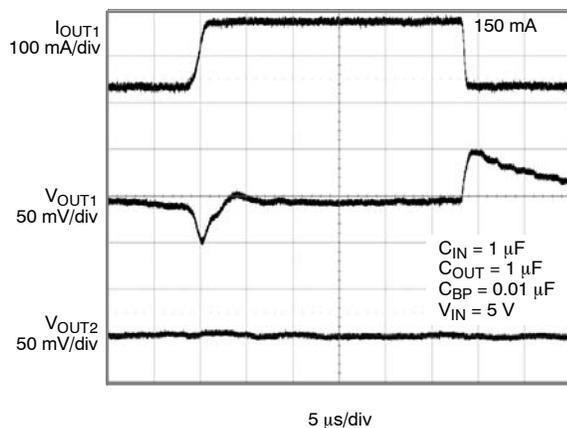
**Enable Sequence**



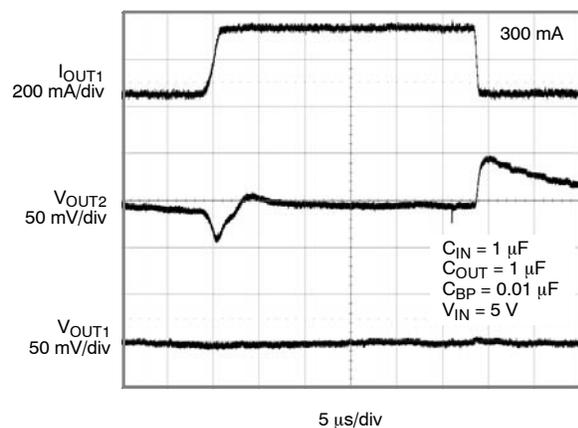
**Power-On Reset Sequence**



**Load Transient Response LDO 1**



**Load Transient Response LDO2**





## DETAILED OPERATION

The SiP2213 is a low drop out, low quiescent current monolithic dual linear regulator, with power-on reset and open drain driver output features. With output voltage range from 1.25 V to 5 V the first regulator can source 150 mA and the second regulator can source 300 mA. The regulators are sequentially turned on with the 150 mA regulator turned on first and then the 300-mA regulator. The open drain driver has the capability to drive LED's for backlighting applications.

### $V_{IN}$

$V_{IN}$  is the input supply pin for both LDO's. The bypass capacitor for this pin is not critical as long as the input supply has low enough source impedance. For practical circuits, a 1.0  $\mu$ F or larger ceramic capacitor is recommended. When the source impedance is not low enough and/or the source is several inches from the SiP2213, then a larger input bypass capacitor is needed. When the source impedance, wire and trace impedance are unknown, it is recommended that an input bypass capacitor be used of a value that is equal to or greater than the output capacitor.

### $V_{OUT1,2}$ (LDO Outputs)

The  $V_{OUT}$  is the output voltage of the regulator. Connect a bypass capacitor from  $V_{OUTX}$  to ground. The output capacitor can be any value from 1.0  $\mu$ F to 10.0  $\mu$ F. A ceramic capacitor with X5R or X7R dielectric type is recommended for best output noise, line transient, and load transient performance.

### Enable

The Enable pin controls the turning on and off of both regulators of the SiP2213.  $V_{OUT}$  of both outputs are guaranteed to be on when the Enable pin voltage is equal or greater than 1.8 V; the regulators are sequentially turned on

with the 150 mA regulator turned on first and then the 300mA regulator.  $V_{OUT}$  is guaranteed to be off when the Enable pin voltage equals or is less than 0.6 V. To automatically turn on  $V_{OUT}$  whenever the Input is applied, tie the Enable pin to  $V_{IN}$ .

### Power-On Reset (POR)

The POR is an open drain output that goes low when  $V_{OUT2}$  is less than 5% of its nominal value. As with any open drain output, an external pull up resistor is needed. The POR pin is disconnected if not used.

### SET

When a capacitor is connected from SET to GROUND, the POR signal transition from low to high is delayed. This delayed POR signal can be used as the power-on reset signal for the application system. To set the POR delay time refer to the POR Delay curve to determine the capacitor value.

The Set pin should be an open circuit if not used.

### OPEN-Drain Driver (DRV)

The SW pin a logic level input put that controls the DRV pin. The switch pin is an active high input and should not be left floating. The drive pin is an open drain output able to sink 150 mA of current.

### Bypass Capacitor

For low noise application and/or increase in power supply rejection ration (PSRR) connect a high frequency ceramic capacitor from BP to ground. A 0.01- $\mu$ F X5R or X7R ceramic capacitor is recommended.